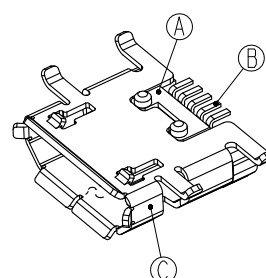
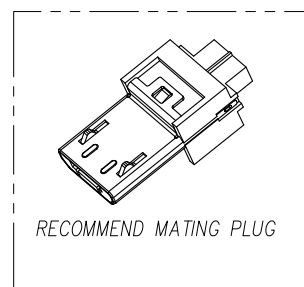
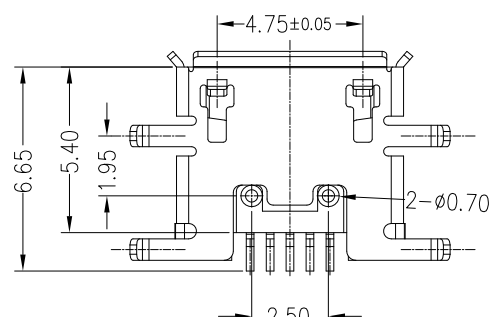
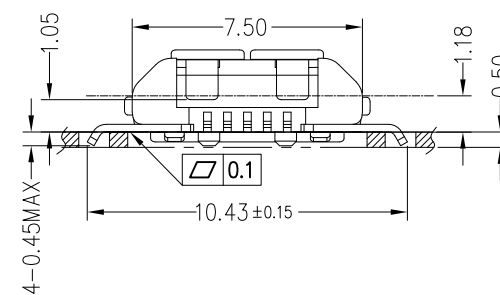
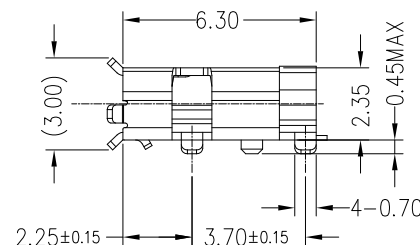
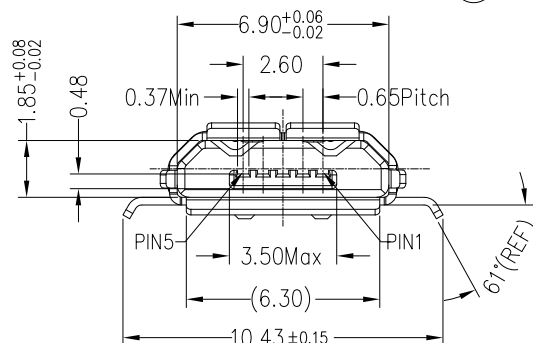
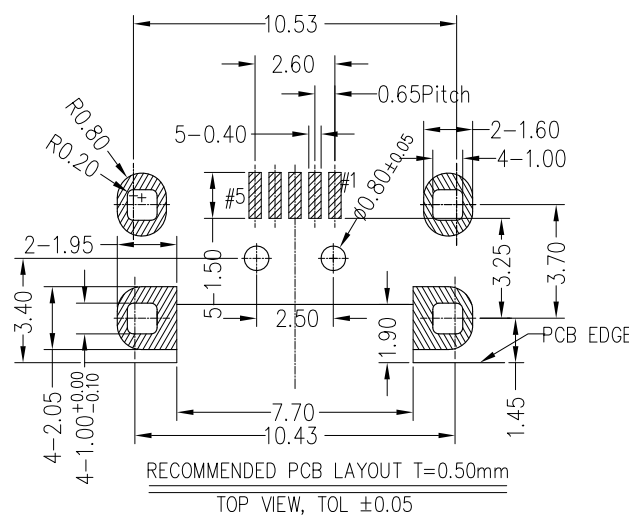
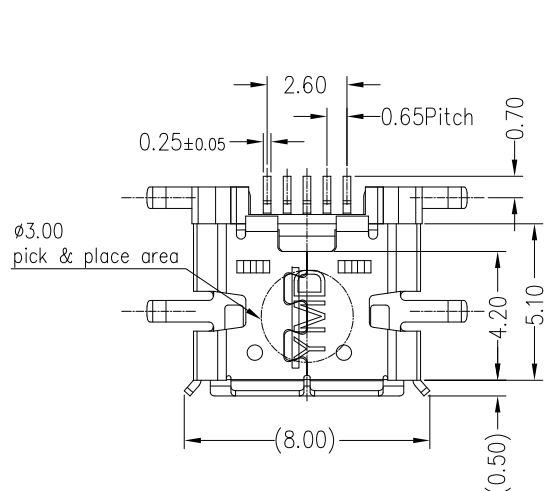


REV.	ECN NO OR DESCRIPTION	REVISED	DATE
A	PRODUCT RELEASE	Ares	2012.12.26

SPECIFICATIONS:

- ELECTRICAL CHARACTERISTICS:
 - 1-1. RATING: 1.8A (PIN1/5), 0.5A (PIN2/3/4)
 - 1-2. CONTACT RESISTANCE: 30m Ω MAX.(INITIAL)40m Ω MAX.(FINAL)
 - 1-3. DIELECTRIC WITHSTANDING VOLTAGE: 500V AC FOR ONE MINUTE.
 - 1-4. INSULATION RESISTANCE: 100M Ω MIN. MEASURED BY 500 VDC
- MECHANICAL CHARACTERISTICS:
 - 2-1. INSERTION FORCE : 3.6 KGF (MAX)
 - 2-2. WITHDRAWAL FORCE : 0.8 KGF(Reference)
- LIFE TEST: 10,000 CYCLES .
- TO CONFORM TO THE SINGATRON HSF SPEC.
- HALOGEN FREE PRODUCT IDENTIFICATION MARK ON PRODUCT: 
- HALOGEN FREE PRODUCT IDENTIFICATION LABEL ON PACKAGING: 
- FOR REFLOW SOLDERING LEAD-FREE PROCESS.
- SOLDER HEAT RESISTANCE REFLOW SOLDERING 260°C 10SECS.
- PLUG INTERFACE DIMENSIONS COMFORM TO USB2.0 SPEC.
- PACKAGING: TAPE & REEL.



C	SHELL	1	STAINLESS STEEL 0.25T	Au 3u"Min ON SOLDER AREA Ni 50u"Min PLATING ALL OVER
B	CONTACT	5	COPPER ALLOY 0.15T	30u"Au ON CONTACT AREA GOLD FLASH ON SOLDER AREA ALL OVER NICKEL PLATED.
A	HOUSING	1	HI-TEMP. THERMO- PLASTIC UL94V-0	BLACK
NO	DESCRIPTION	QTY	MATERIAL	PLATING & COLOR
UNLESS OTHERWISE SPECIFIED TOLERANCES		 Singatron Enterprise Co., Ltd. 信音企業股份有限公司		
DECIMALS: ANGLES:		TITLE MICRO USB B TYPE REVERSE RECEPTACLE		
X :±0.5	X :±2°	DWN Ares 2012.12.26	PART NO. 2UB2132-000111F	
X.X :±0.3	X.X :±1°	CHKD Winkon 2012.12.27	SCALE 4:1	UNIT: mm
X.XX :±0.2		APVD Winkon 2012.12.27	SIZE: A3	SHEET: 1 OF 1 REV:A
CUSTOMER COPY				